

L Number	Hits	Search Text	DB	Time stamp
1	3	("3873870").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/27 08:27
3	103	flat with lamp and discharge and dielectric adj layer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/27 08:55
4	33	flat with lamp and discharge and dielectric adj layer same substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/27 11:45
5	28	flat with lamp and discharge and diffusion same substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/27 11:46
-	17	flat with lamp and (adhesive same substrate) and discharge and frame	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/27 08:51
-	1911	flat and adhesive and substrate and discharge and frame	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/24 08:56
-	510	flat and lamp and adhesive and substrate and discharge and frame	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/24 11:14
-	12	"flat luminescent lamp"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/24 11:15
-	115	(discharge with lamp) and (substrate same adhesive) and frame	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/24 13:25
-	3370	(313/485,488,491,494,495,498,502,281,582).	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/24 13:26
-	763	((313/485,488,491,494,495,498,502,281,582) and substrate and discharge	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/24 13:27
-	129	((313/485,488,491,494,495,498,502,281,582) and substrate and discharge and adhesive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/24 13:53
-	69	((313/485,488,491,494,495,498,502,281,582) and substrate and discharge and adhesive) and phosphor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/02/24 14:28

-	2913	(313/484,486-487,503-506).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/25 09:11
-	99	((313/484,486-487,503-506).CCLS.) and substrate and discharge and phosphor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/25 11:09
-	1066	(313/492-493).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/25 11:09
-	352	(313/581).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/25 11:16
-	68066	park.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/25 12:36
-	12	"894903"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/25 12:36
-	364	((313/485,488,491,494,495,498,502,281,582) and substrate and discharge) and phosphor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/25 14:28
-	49	((313/492-493).CCLS.) and substrate and discharge and phosphor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/25 14:28
-	30	((313/581).CCLS.) and substrate and discharge and phosphor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/25 14:28
-	417	((313/485,488,491,494,495,498,502,281,582) and substrate and discharge) and phosphor) ((313/492-493).CCLS.) and substrate and discharge and phosphor)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/25 14:28
-	165	((313/581).CCLS.) and substrate and discharge and phosphor) ((313/492-493).CCLS.) and substrate and discharge and phosphor) ((313/581).CCLS.) and substrate and discharge and phosphor)) and (ITO "indium tin oxide")	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/25 14:29